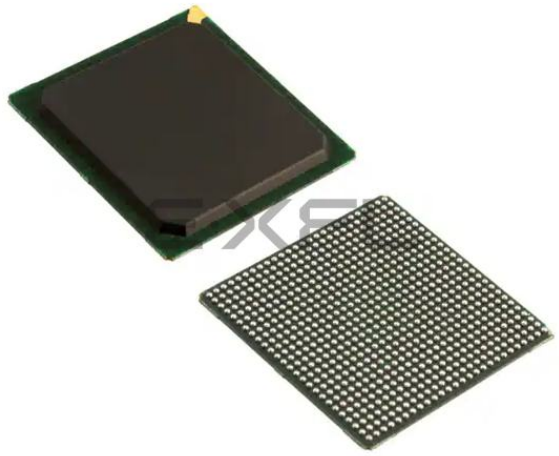
AMD Xilinx - XC2VP30-6FGG676C Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	3424
Number of Logic Elements/Cells	30816
Total RAM Bits	2506752
Number of I/O	416
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp30-6fgg676c

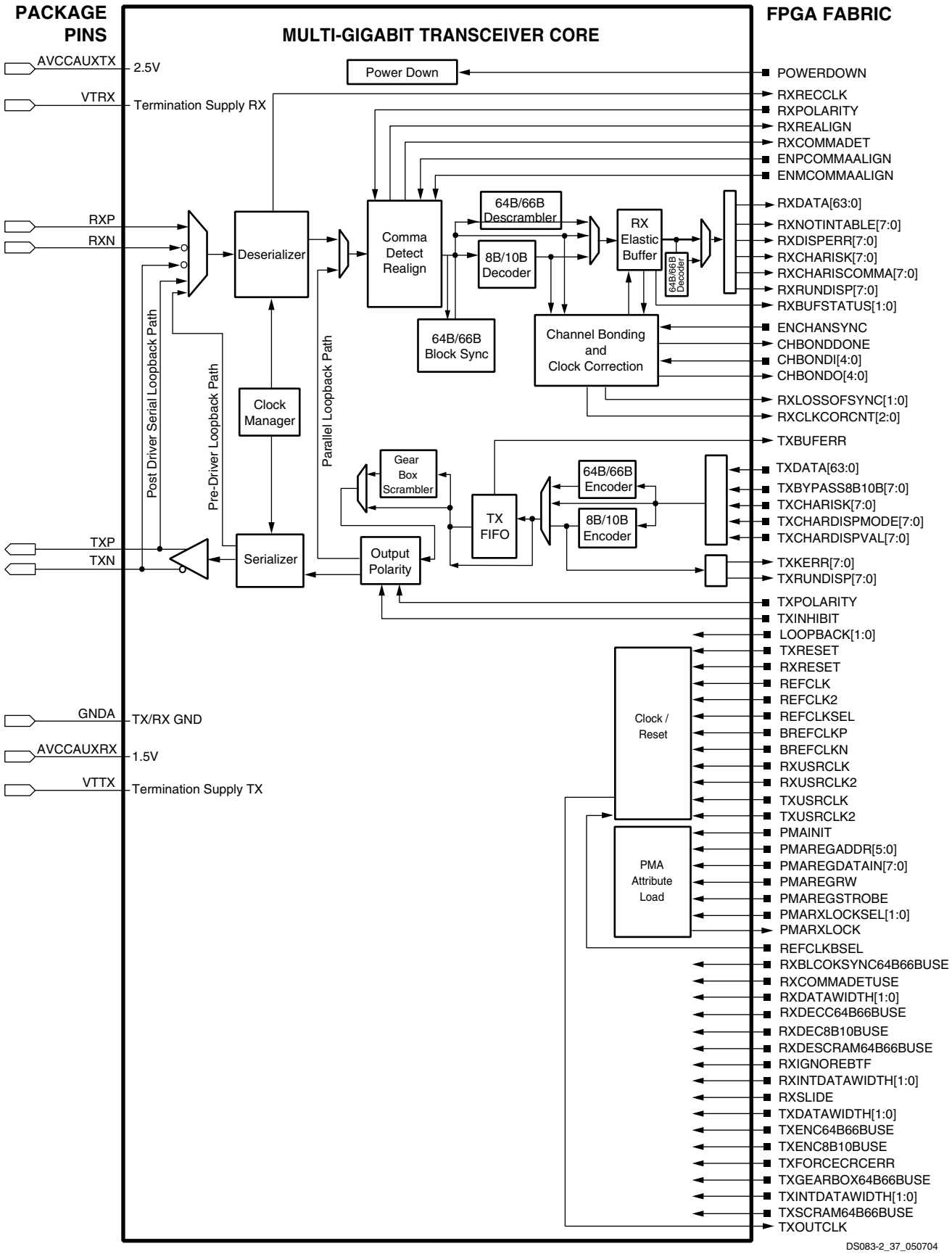

Figure 4: **RocketIO X Transceiver Block Diagram**

Multiplexers

Virtex-II Pro function generators and associated multiplexers can implement the following:

- 4:1 multiplexer in one slice
- 8:1 multiplexer in two slices
- 16:1 multiplexer in one CLB element (4 slices)
- 32:1 multiplexer in two CLB elements (8 slices)

Each Virtex-II Pro slice has one MUXF5 multiplexer and one MUXFX multiplexer. The MUXFX multiplexer implements the MUXF6, MUXF7, or MUXF8, as shown in Figure 41. Each CLB element has two MUXF6 multiplexers, one MUXF7 multiplexer and one MUXF8 multiplexer. Examples of multiplexers are shown in the *Virtex-II Pro Platform FPGA User Guide*. Any LUT can implement a 2:1 multiplexer.

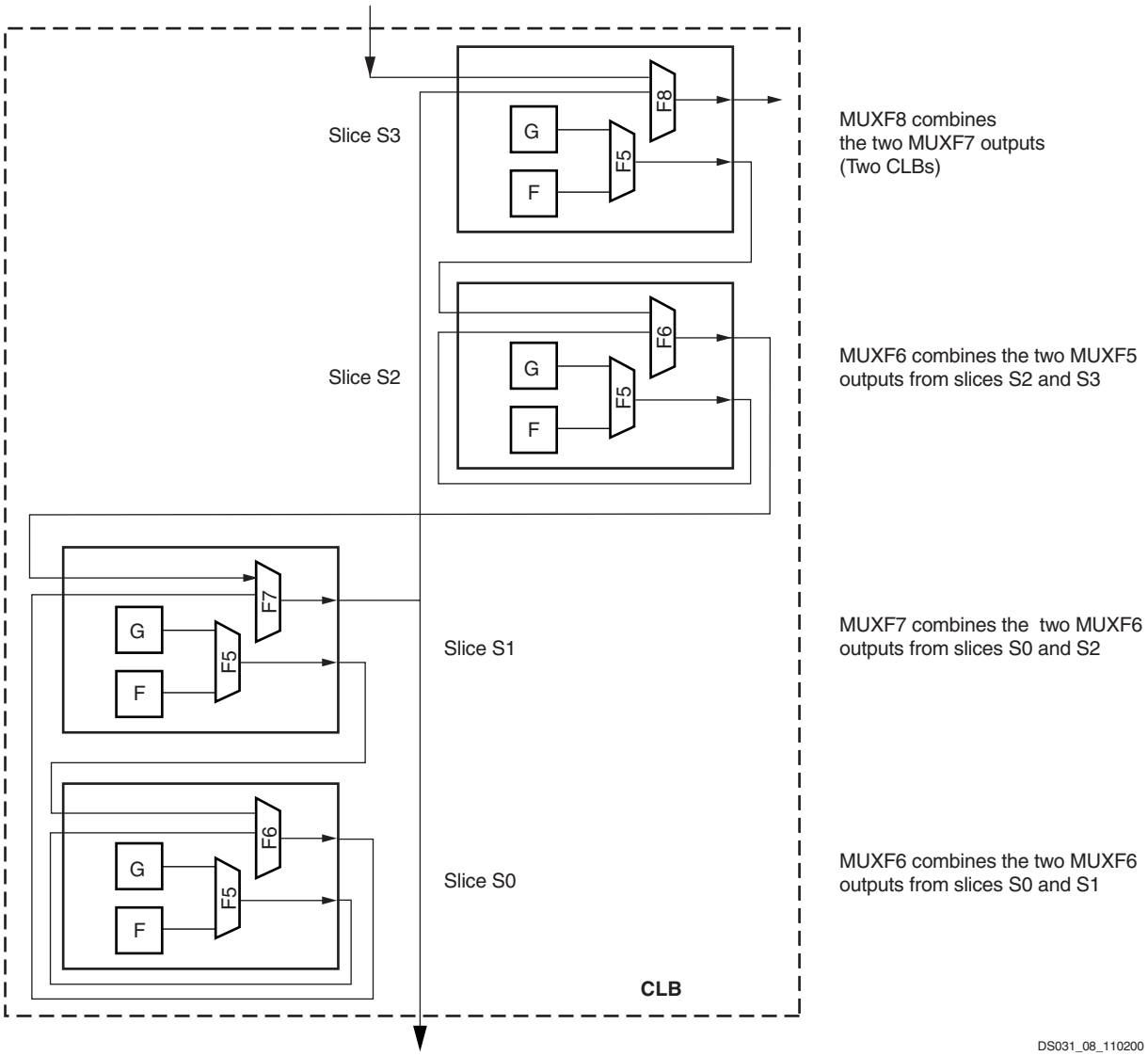

Figure 41: **MUXF5 and MUXFX multiplexers**

Fast Lookahead Carry Logic

Dedicated carry logic provides fast arithmetic addition and subtraction. The Virtex-II Pro CLB has two separate carry chains, as shown in the Figure 42.

The height of the carry chains is two bits per slice. The carry chain in the Virtex-II Pro device is running upward. The dedicated carry path and carry multiplexer (MUXCY) can also be used to cascade function generators for implementing wide logic functions.

Arithmetic Logic

The arithmetic logic includes an XOR gate that allows a 2-bit full adder to be implemented within a slice. In addition, a dedicated AND (MULT_AND) gate (shown in Figure 34) improves the efficiency of multiplier implementation.

LVDS DC Specifications (LVDS_25)

Table 8: **LVDS DC Specifications**

DC Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage	V_{CCO}		2.38	2.5	2.63	V
Output High Voltage for Q and $\overline{Q}$	V_{OH}	R_T = 100 Ω across Q and $\overline{Q}$ signals			1.602	V
Output Low Voltage for Q and $\overline{Q}$	V_{OL}	R_T = 100 Ω across Q and $\overline{Q}$ signals	0.898			V
Differential Output Voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High	V_{ODIFF}	R_T = 100 Ω across Q and $\overline{Q}$ signals	247	350	454	mV
Output Common-Mode Voltage	V_{OCM}	R_T = 100 Ω across Q and $\overline{Q}$ signals	1.125	1.250	1.375	V
Differential Input Voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High	V_{IDIFF}	Common-mode input voltage = 1.25V	100	350	600	mV
Input Common-Mode Voltage	V_{ICM}	Differential input voltage = ±350 mV	0.3	1.2	2.2	V

Extended LVDS DC Specifications (LVDSEXT_25)

Table 9: **Extended LVDS DC Specifications**

DC Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage	V_{CCO}		2.38	2.5	2.63	V
Output High Voltage for Q and $\overline{Q}$	V_{OH}	R_T = 100 Ω across Q and $\overline{Q}$ signals			1.785	V
Output Low Voltage for Q and $\overline{Q}$	V_{OL}	R_T = 100 Ω across Q and $\overline{Q}$ signals	0.715			V
Differential Output Voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High	V_{ODIFF}	R_T = 100 Ω across Q and $\overline{Q}$ signals	440		820	mV
Output Common-Mode Voltage	V_{OCM}	R_T = 100 Ω across Q and $\overline{Q}$ signals	1.125	1.250	1.375	V
Differential Input Voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High	V_{IDIFF}	Common-mode input voltage = 1.25V	100		1000	mV
Input Common-Mode Voltage	V_{ICM}	Differential input voltage = ±350 mV	0.3	1.2	2.2	V

LVPECL DC Specifications (LVPECL_25)

These values are valid when driving a 100 Ω differential load only, i.e., a 100 Ω resistor between the two receiver pins. The V_{OH} levels are 200 mV below standard LVPECL levels and are compatible with devices tolerant of lower common-mode ranges. Table 10 summarizes the DC output specifications of LVPECL. For more information on using LVPECL, see the *Virtex-II Pro Platform FPGA User Guide*.

Table 10: **LVPECL DC Specifications**

DC Parameter	V_{CCO} = 2.375V		V_{CCO} = 2.5V		V_{CCO} = 2.625V		Units
	Min	Max	Min	Max	Min	Max	
V_{OH}	1.35	1.495	1.475	1.62	1.6	1.745	V
V_{OL}	0.565	0.755	0.69	0.88	0.815	1.005	V
V_{IH}	0.8	2.0	0.8	2.0	0.8	2.0	V
V_{IL}	0.5	1.7	0.5	1.7	0.5	1.7	V
Differential Input Voltage	0.100	1.5	0.100	1.5	0.100	1.5	V

Virtex-II Pro Switching Characteristics

Switching characteristics are specified on a per-speed-grade basis and can be designated as Advance, Preliminary, or Production. Note that Virtex-II Pro Performance Characteristics are subject to these guidelines, as well. Each designation is defined as follows:

Advance: These speed files are based on simulations only and are typically available soon after device design specifications are frozen. Although speed grades with this designation are considered relatively stable and conservative, some under-reporting might still occur.

Preliminary: These speed files are based on complete ES (engineering sample) silicon characterization. Devices and speed grades with this designation are intended to give a better indication of the expected performance of production silicon. The probability of under-reporting delays is greatly reduced as compared to Advance data.

Production: These speed files are released once enough production silicon of a particular device family member has been characterized to provide full correlation between speed files and devices over numerous production lots. There is no under-reporting of delays, and customers receive formal notification of any subsequent changes. Typically, the slowest speed grades transition to Production before faster speed grades.

Since individual family members are produced at different times, the migration from one category to another depends completely on the status of the fabrication process for each device. Table 15 correlates the current status of each Virtex-II Pro device with a corresponding speed file designation.

All specifications are always representative of worst-case supply voltage and junction temperature conditions.

Table 15: **Virtex-II Pro Device Speed Grade Designations**

Device	Speed Grade Designations		
	Advance	Preliminary	Production
XC2VP2			-7, -6, -5
XC2VP4			-7, -6, -5
XC2VP7			-7, -6, -5
XC2VP20			-7, -6, -5
XC2VPX20		-6, -5	
XC2VP30			-7, -6, -5
XC2VP40			-7, -6, -5
XC2VP50			-7, -6, -5
XC2VP70			-7, -6, -5
XC2VPX70		-6, -5	
XC2VP100			-6, -5

Testing of Switching Characteristics

All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotate to the simulation net list. Unless otherwise noted, values apply to all Virtex-II Pro devices.

PowerPC Switching Characteristics

Table 16: **Processor Clocks Absolute AC Characteristics**

Description	Speed Grade						Units
	-7		-6		-5		
	Min	Max	Min	Max	Min	Max	
CPMC405CLOCK frequency	0	400(1)	0	350(1)	0	300	MHz
JTAGC405TCK frequency(2)	0	200	0	175	0	150	MHz
PLBCLK(3)	0	400	0	350	0	300	MHz
BRAMDSOCMCLK(3)	0	400	0	350	0	300	MHz
BRAMISOCMCLK(3)	0	400	0	350	0	300	MHz

Notes:

1. **IMPORTANT!** When CPMC405CLOCK runs at speeds greater than 350 MHz in -7 Commercial grade dual-processor devices, or greater than 300 MHz in -6 Industrial grade dual-processor devices, users must implement the technology presented in **XAPP755**, "PowerPC 405 Clock Macro for -7(C) and -6(I) Speed Grade Dual-Processor Devices." Refer to Table 1, Module 1 to identify dual-processor devices.
2. The theoretical maximum frequency of this clock is one-half the CPMC405CLOCK. However, the achievable maximum is dependent on the system, and will be much less.
3. The theoretical maximum frequency of these clocks is equal to the CPMC405CLOCK. However, the achievable maximum is dependent on the system. Please see ***PowerPC 405 Processor Block Reference Guide*** and **XAPP640** for more information.

Virtex-II Pro Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. Listed below are representative values for typical pin locations and normal clock loading. Values are expressed in nanoseconds unless otherwise noted.

Global Clock Input to Output Delay for LVCMOS25, 12 mA, Fast Slew Rate, *With* DCM

Table 53: **Global Clock Input to Output Delay for LVCMOS25, 12 mA, Fast Slew Rate, *With* DCM**

			Speed Grade			
Description	**Symbol**	**Device**	**-7**	**-6**	**-5**	**Units**
LVCMOS25 Global Clock Input to Output Delay using Output Flip-flop, 12 mA, Fast Slew Rate, *with* DCM. For data *output* with different standards, adjust the delays with the values shown in IOB Output Switching Characteristics Standard Adjustments, page 28.						
Global Clock and OFF with DCM	$T_{ICKOFDCM}$	XC2VP2	1.55	1.59	1.62	ns
		XC2VP4	1.58	1.61	1.65	ns
		XC2VP7	1.63	1.68	1.72	ns
		XC2VP20	1.68	1.74	1.79	ns
		XC2VPX20	1.68	1.74	1.79	ns
		XC2VP30	1.68	1.75	1.80	ns
		XC2VP40	1.71	1.86	1.92	ns
		XC2VP50	1.80	2.00	2.07	ns
		XC2VP70	1.87	2.07	2.24	ns
		XC2VPX70	1.87	2.07	2.24	ns
		XC2VP100	N/A	2.38	2.45	ns

Notes:
1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. Output timing is measured at 50% V_{CC} threshold with test setup shown in Figure 6. For other I/O standards, see Table 40.
3. DCM output jitter is already included in the timing calculation.

Input Clock Tolerances

Table 58: **Input Clock Tolerances**

Description	Symbol	Constraints F_{CLKIN}	Speed Grade						Units
			–7		–6		–5		
			Min	Max	Min	Max	Min	Max	
Input Clock Low/High Pulse Width									
PSCLK	PSCLK_PULSE	< 1MHz	25.00		25.00		25.00		ns
PSCLK and CLKIN(3)	PSCLK_PULSE and CLKIN_PULSE	1 – 10 MHz	25.00		25.00		25.00		ns
		10 – 25 MHz	10.00		10.00		10.00		ns
		25 – 50 MHz	5.00		5.00		5.00		ns
		50 – 100 MHz	3.00		3.00		3.00		ns
		100 – 150 MHz	2.40		2.40		2.40		ns
		150 – 200 MHz	2.00		2.00		2.00		ns
		200 – 250 MHz	1.80		1.80		1.80		ns
		250 – 300 MHz	1.50		1.50		1.50		ns
		300 – 350 MHz	1.30		1.30		1.30		ns
		350 – 400 MHz	1.15		1.15		1.15		ns
		> 400 MHz	1.05		1.05		1.05		ns
Input Clock Cycle-Cycle Jitter (Low Frequency Mode)									
CLKIN (using DLL outputs)(1)	CLKIN_CYC_JITT_DLL_LF			±300		±300		±300	ps
CLKIN (using CLKFX outputs)(2)	CLKIN_CYC_JITT_FX_LF			±300		±300		±300	ps
Input Clock Cycle-Cycle Jitter (High Frequency Mode)									
CLKIN (using DLL outputs)(1)	CLKIN_CYC_JITT_DLL_HF			±150		±150		±150	ps
CLKIN (using CLKFX outputs)(2)	CLKIN_CYC_JITT_FX_HF			±150		±150		±150	ps
Input Clock Period Jitter (Low Frequency Mode)									
CLKIN (using DLL outputs)(1)	CLKIN_PER_JITT_DLL_LF			±1		±1		±1	ns
CLKIN (using CLKFX outputs)(2)	CLKIN_PER_JITT_FX_LF			±1		±1		±1	ns
Input Clock Period Jitter (High Frequency Mode)									
CLKIN (using DLL outputs)(1)	CLKIN_PER_JITT_DLL_HF			±1		±1		±1	ns
CLKIN (using CLKFX outputs)(2)	CLKIN_PER_JITT_FX_HF			±1		±1		±1	ns
Feedback Clock Path Delay Variation									
CLKFB off-chip feedback	CLKFB_DELAY_VAR_EXT			±1		±1		±1	ns

Notes:
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. If both DLL and CLKFX outputs are used, follow the more restrictive specification.
3. If DCM phase shift feature is used and CLKIN frequency > 200 Mhz, CLKIN duty cycle must be within ±5% (45/55 to 55/45).

Miscellaneous Timing Parameters

Table 61: **Miscellaneous Timing Parameters**

Description	Symbol	Constraints F_{CLKIN}	Speed Grade			Units
			-7	-6	-5	
Time Required to Achieve LOCK						
Using DLL outputs(1)	LOCK_DLL:					
	LOCK_DLL_60	> 60MHz	20.00	20.00	20.00	us
	LOCK_DLL_50_60	50 - 60 MHz	25.00	25.00	25.00	us
	LOCK_DLL_40_50	40 - 50 MHz	50.00	50.00	50.00	us
	LOCK_DLL_30_40	30 - 40 MHz	90.00	90.00	90.00	us
	LOCK_DLL_24_30	24 - 30 MHz	120.00	120.00	120.00	us
Using CLKFX outputs	LOCK_FX_MIN		10.00	10.00	10.00	ms
	LOCK_FX_MAX		10.00	10.00	10.00	ms
Additional lock time with fine phase shifting	LOCK_DLL_FINE_SHIFT		50.00	50.00	50.00	us
Fine Phase Shifting						
Absolute shifting range	FINE_SHIFT_RANGE		10.00	10.00	10.00	ns
Delay Lines						
Tap delay resolution	DCM_TAP_MIN		30.00	30.00	30.00	ps
	DCM_TAP_MAX		50.00	50.00	50.00	ps

Notes:
1. “DLL outputs” is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.

Frequency Synthesis

Table 62: **Frequency Synthesis**

Attribute	Min	Max
CLKFX_MULTIPLY	2	32
CLKFX_DIVIDE	1	32

Parameter Cross-Reference

Table 63: **Parameter Cross-Reference**

Libraries Guide	Data Sheet
DLL_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_{1X|2X|DV}_LF
DFS_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_FX_LF
DLL_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_DLL_LF
DFS_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_FX_LF
DLL_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_{1X|DV}_HF
DFS_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_FX_HF
DLL_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_DLL_HF
DFS_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_FX_HF

Table 4: **Virtex-II Pro Pin Definitions *(Continued)***

Pin Name	Direction	Description
VTRXPAD#	Input	Receive termination supply for the RocketIO multi-gigabit transceiver (1.8V - 2.8V).
VTTXPAD#	Input	Transmit termination supply for the RocketIO multi-gigabit transceiver (1.8V - 2.8V).
GNDA#	Input	Ground for the analog circuitry of the RocketIO multi-gigabit transceiver.
RXPPAD#	Input	Positive differential receive port of the RocketIO multi-gigabit transceiver.
RXNPAD#	Input	Negative differential receive port of the RocketIO multi-gigabit transceiver.
TXPPAD#	Output	Positive differential transmit port of the RocketIO multi-gigabit transceiver.
TXNPAD#	Output	Negative differential transmit port of the RocketIO multi-gigabit transceiver.

Notes:
1. All dedicated pins (JTAG and configuration) are powered by V_{CCAUX} (independent of the bank V_{CCO} voltage).
2. Virtex-II Pro X devices XC2VPX20 and XC2VPX70 only. Each BREFCLK(N/P) differential clock input pair takes the place of one regular Virtex-II Pro dual-function IO/GCLKx(S/P) pair on each side of the chip (top or bottom). For RocketIO BREFCLK, see section BREFCLK Pin Definitions (RocketIO Only) immediately following.

BREFCLK Pin Definitions (RocketIO Only)

These dedicated clocks use the same clock inputs for all packages:

Top	BREFCLK	P	GCLK4S	Bottom	BREFCLK	P	GCLK6P
		N	GCLK5P			N	GCLK7S
	BREFCLK2	P	GCLK2S		BREFCLK2	P	GCLK0P
		N	GCLK3P			N	GCLK1S

For detailed information about using BREFCLK/BREFCLK2, including routing considerations and pin numbers for all package types, refer to Chapter 2, "Digital Design Considerations," in the **RocketIO Transceiver User Guide**.

Table 7: **FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
1	IO_L45N_1/VREF_1	C18			
1	IO_L45P_1	D18			
1	IO_L43N_1	E18			
1	IO_L43P_1	F18			
1	IO_L39N_1	G18			
1	IO_L39P_1	H18			
1	IO_L37N_1	A19			
1	IO_L37P_1	B19			
1	IO_L09N_1/VREF_1	E19			
1	IO_L09P_1	F19			
1	IO_L07N_1	G19			
1	IO_L07P_1	H19			
1	IO_L06N_1	C20			
1	IO_L06P_1	D20			
1	IO_L05_1/No_Pair	E20			
1	IO_L03N_1/VREF_1	F20			
1	IO_L03P_1	G20			
1	IO_L02N_1	D21			
1	IO_L02P_1	E21			
1	IO_L01N_1/VRP_1	D22			
1	IO_L01P_1/VRN_1	E22			
2	IO_L01N_2/VRP_2	C25			
2	IO_L01P_2/VRN_2	C26			
2	IO_L02N_2	D25			
2	IO_L02P_2	D26			
2	IO_L03N_2	E23			
2	IO_L03P_2	F22			
2	IO_L04N_2/VREF_2	E25			
2	IO_L04P_2	E26			
2	IO_L06N_2	F21			
2	IO_L06P_2	G21			
2	IO_L24N_2	F23	NC		
2	IO_L24P_2	F24	NC		
2	IO_L31N_2	F25			

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
0	IO_L53_0/No_Pair		A21	NC		
0	IO_L54N_0		H18	NC		
0	IO_L54P_0		G18	NC		
0	IO_L56N_0		C21	NC		
0	IO_L56P_0		C20	NC		
0	IO_L57N_0		J17	NC		
0	IO_L57P_0/VREF_0		H17	NC		
0	IO_L67N_0		E17			
0	IO_L67P_0		D17			
0	IO_L68N_0		D18			
0	IO_L68P_0		C18			
0	IO_L69N_0		J16			
0	IO_L69P_0/VREF_0		H16			
0	IO_L73N_0		E16			
0	IO_L73P_0		D16			
0	IO_L74N_0/GCLK7P		C16			
0	IO_L74P_0/GCLK6S		B16			
0	IO_L75N_0/GCLK5P	BREFCLKN	G16			
0	IO_L75P_0/GCLK4S	BREFCLKP	F16			
1	IO_L75N_1/GCLK3P		F15			
1	IO_L75P_1/GCLK2S		G15			
1	IO_L74N_1/GCLK1P		B15			
1	IO_L74P_1/GCLK0S		C15			
1	IO_L73N_1		D15			
1	IO_L73P_1		E15			
1	IO_L69N_1/VREF_1		H15			
1	IO_L69P_1		J15			
1	IO_L68N_1		C13			
1	IO_L68P_1		D13			
1	IO_L67N_1		D14			
1	IO_L67P_1		E14			
1	IO_L57N_1/VREF_1		H14	NC		
1	IO_L57P_1		J14	NC		
1	IO_L56N_1		C11	NC		
1	IO_L56P_1		C10	NC		

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
3	IO_L57P_3		Y1			
3	IO_L56N_3		U7			
3	IO_L56P_3		U8			
3	IO_L55N_3		V5			
3	IO_L55P_3		V6			
3	IO_L54N_3		Y2			
3	IO_L54P_3		AA2			
3	IO_L53N_3		V7			
3	IO_L53P_3		V8			
3	IO_L52N_3		W3			
3	IO_L52P_3		W4			
3	IO_L51N_3/VREF_3		AA1			
3	IO_L51P_3		AB1			
3	IO_L50N_3		W5			
3	IO_L50P_3		W6			
3	IO_L49N_3		Y4			
3	IO_L49P_3		Y5			
3	IO_L48N_3		AA3			
3	IO_L48P_3		AA4			
3	IO_L47N_3		W7			
3	IO_L47P_3		W8			
3	IO_L46N_3		AB3			
3	IO_L46P_3		AB4			
3	IO_L45N_3/VREF_3		AB2			
3	IO_L45P_3		AC2			
3	IO_L44N_3		AA5			
3	IO_L44P_3		AA6			
3	IO_L43N_3		AC3			
3	IO_L43P_3		AC4			
3	IO_L42N_3		AD1	NC		
3	IO_L42P_3		AD2	NC		
3	IO_L41N_3		Y7	NC		
3	IO_L41P_3		Y8	NC		
3	IO_L40N_3		AB5	NC		
3	IO_L40P_3		AB6	NC		
3	IO_L39N_3/VREF_3		AE1	NC		

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
2	IO_L38N_2	N10				
2	IO_L38P_2	N9				
2	IO_L39N_2	M7				
2	IO_L39P_2	M6				
2	IO_L40N_2/VREF_2	L2				
2	IO_L40P_2	M2				
2	IO_L41N_2	N8				
2	IO_L41P_2	N7				
2	IO_L42N_2	L4				
2	IO_L42P_2	L3				
2	IO_L43N_2	M4				
2	IO_L43P_2	M3				
2	IO_L44N_2	P10				
2	IO_L44P_2	P9				
2	IO_L45N_2	N6				
2	IO_L45P_2	N5				
2	IO_L46N_2/VREF_2	M1				
2	IO_L46P_2	N1				
2	IO_L47N_2	P8				
2	IO_L47P_2	P7				
2	IO_L48N_2	N4				
2	IO_L48P_2	N3				
2	IO_L49N_2	N2				
2	IO_L49P_2	P2				
2	IO_L50N_2	R10				
2	IO_L50P_2	R9				
2	IO_L51N_2	P6				
2	IO_L51P_2	P5				
2	IO_L52N_2/VREF_2	P4				
2	IO_L52P_2	P3				
2	IO_L53N_2	T11				
2	IO_L53P_2	U11				
2	IO_L54N_2	R7				
2	IO_L54P_2	R6				
2	IO_L55N_2	P1				
2	IO_L55P_2	R1				
2	IO_L56N_2	T10				
2	IO_L56P_2	T9				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
7	IO_L43N_7	M31				
7	IO_L42P_7	L32				
7	IO_L42N_7	L31				
7	IO_L41P_7	N28				
7	IO_L41N_7	N27				
7	IO_L40P_7	M33				
7	IO_L40N_7/VREF_7	L33				
7	IO_L39P_7	M29				
7	IO_L39N_7	M28				
7	IO_L38P_7	N26				
7	IO_L38N_7	N25				
7	IO_L37P_7	L34				
7	IO_L37N_7	K34				
7	IO_L36P_7	L30				
7	IO_L36N_7	L29				
7	IO_L35P_7	L28				
7	IO_L35N_7	L27				
7	IO_L34P_7	K33				
7	IO_L34N_7/VREF_7	J33				
7	IO_L33P_7	K31				
7	IO_L33N_7	K30				
7	IO_L32P_7	M26				
7	IO_L32N_7	M25				
7	IO_L31P_7	H34				
7	IO_L31N_7	H33				
7	IO_L24P_7	H32	NC			
7	IO_L24N_7	H31	NC			
7	IO_L23P_7	K28	NC			
7	IO_L23N_7	K27	NC			
7	IO_L22P_7	J32	NC			
7	IO_L22N_7/VREF_7	J31	NC			
7	IO_L21P_7	J30	NC			
7	IO_L21N_7	J29	NC			
7	IO_L20P_7	G34	NC			
7	IO_L20N_7	G33	NC			
7	IO_L19P_7	H30	NC			
7	IO_L19N_7	H29	NC			
7	IO_L18P_7	L26	NC			

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
7	IO_L18N_7	L25	NC			
7	IO_L17P_7	F34	NC			
7	IO_L17N_7	F33	NC			
7	IO_L16P_7	G30	NC			
7	IO_L16N_7/VREF_7	G29	NC			
7	IO_L15P_7	G32	NC			
7	IO_L15N_7	G31	NC			
7	IO_L06P_7	F31				
7	IO_L06N_7	F30				
7	IO_L05P_7	J28				
7	IO_L05N_7	J27				
7	IO_L04P_7	E34				
7	IO_L04N_7/VREF_7	E33				
7	IO_L03P_7	E32				
7	IO_L03N_7	E31				
7	IO_L02P_7	F28				
7	IO_L02N_7	F27				
7	IO_L01P_7/VRN_7	D34				
7	IO_L01N_7/VRP_7	D33				
0	VCCO_0	C29				
0	VCCO_0	E20				
0	VCCO_0	F25				
0	VCCO_0	L20				
0	VCCO_0	L21				
0	VCCO_0	L22				
0	VCCO_0	L23				
0	VCCO_0	M18				
0	VCCO_0	M19				
0	VCCO_0	M20				
0	VCCO_0	M21				
0	VCCO_0	M22				
1	VCCO_1	C6				
1	VCCO_1	E15				
1	VCCO_1	F10				
1	VCCO_1	L12				
1	VCCO_1	L13				
1	VCCO_1	L14				

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
6	IO_L52N_6		AE42		
6	IO_L53P_6		AE32		
6	IO_L53N_6		AE33		
6	IO_L54P_6		AD35		
6	IO_L54N_6		AD36		
6	IO_L55P_6		AD37		
6	IO_L55N_6		AD38		
6	IO_L56P_6		AD31		
6	IO_L56N_6		AD32		
6	IO_L57P_6		AD39		
6	IO_L57N_6/VREF_6		AD40		
6	IO_L58P_6		AD41		
6	IO_L58N_6		AD42		
6	IO_L59P_6		AD33		
6	IO_L59N_6		AD34		
6	IO_L60P_6		AC33		
6	IO_L60N_6		AC34		
6	IO_L85P_6		AC36		
6	IO_L85N_6		AC37		
6	IO_L86P_6		AC31		
6	IO_L86N_6		AC32		
6	IO_L87P_6		AC39		
6	IO_L87N_6/VREF_6		AC40		
6	IO_L88P_6		AB33		
6	IO_L88N_6		AB34		
6	IO_L89P_6		AB36		
6	IO_L89N_6		AB37		
6	IO_L90P_6		AB39		
6	IO_L90N_6		AB40		
7	IO_L90P_7		AA39		
7	IO_L90N_7		AA40		
7	IO_L89P_7		AB31		
7	IO_L89N_7		AA31		
7	IO_L88P_7		AA36		
7	IO_L88N_7/VREF_7		AA37		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	VCCINT		AF16		
N/A	VCCINT		AG27		
N/A	VCCINT		AG26		
N/A	VCCINT		AG25		
N/A	VCCINT		AG24		
N/A	VCCINT		AG23		
N/A	VCCINT		AG22		
N/A	VCCINT		AG21		
N/A	VCCINT		AG20		
N/A	VCCINT		AG19		
N/A	VCCINT		AG18		
N/A	VCCINT		AG17		
N/A	VCCINT		AG16		
N/A	VCCINT		AH28		
N/A	VCCINT		AH27		
N/A	VCCINT		AH26		
N/A	VCCINT		AH17		
N/A	VCCINT		AH16		
N/A	VCCINT		AH15		
N/A	VCCINT		AJ29		
N/A	VCCINT		AJ28		
N/A	VCCINT		AJ27		
N/A	VCCINT		AJ16		
N/A	VCCINT		AJ15		
N/A	VCCINT		AJ14		
N/A	VCCINT		AK30		
N/A	VCCINT		AK13		
N/A	VCCINT		AA27		
N/A	VCCINT		AA16		
N/A	VCCINT		Y27		
N/A	VCCINT		Y16		
N/A	VCCINT		W27		
N/A	VCCINT		W16		
N/A	VCCINT		V27		
N/A	VCCINT		V16		
N/A	VCCINT		U27		

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
1	IO_L57P_1	E19	
1	IO_L56N_1	K18	
1	IO_L56P_1	J18	
1	IO_L55N_1	H19	
1	IO_L55P_1	H20	
1	IO_L54N_1	B18	
1	IO_L54P_1	A18	
1	IO_L53_1/No_Pair	L18	
1	IO_L50_1/No_Pair	L19	
1	IO_L49N_1	C18	
1	IO_L49P_1	C19	
1	IO_L48N_1	F18	
1	IO_L48P_1	E18	
1	IO_L47N_1	L17	
1	IO_L47P_1	K17	
1	IO_L46N_1	G18	
1	IO_L46P_1	G19	
1	IO_L18N_1/VREF_1	C17	NC
1	IO_L18P_1	B17	NC
1	IO_L12N_1	G17	NC
1	IO_L12P_1	F17	NC
1	IO_L11N_1	M17	NC
1	IO_L11P_1	M18	NC
1	IO_L10N_1	B16	NC
1	IO_L10P_1	A16	NC
1	IO_L45N_1/VREF_1	D16	
1	IO_L45P_1	D17	
1	IO_L44N_1	K16	
1	IO_L44P_1	J16	
1	IO_L43N_1	F16	
1	IO_L43P_1	E16	
1	IO_L39N_1	H16	
1	IO_L39P_1	H17	
1	IO_L38N_1	M16	
1	IO_L38P_1	L16	
1	IO_L37N_1	B15	
1	IO_L37P_1	A15	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
4	IO_L26P_4	AU12	
4	IO_L27N_4	AR12	
4	IO_L27P_4/VREF_4	AP12	
4	IO_L28N_4	AW13	
4	IO_L28P_4	AW12	
4	IO_L29N_4	BA12	
4	IO_L29P_4	AY12	
4	IO_L30N_4	AN13	
4	IO_L30P_4	AM13	
4	IO_L34N_4	AU13	
4	IO_L34P_4	AT13	
4	IO_L35N_4	BA13	
4	IO_L35P_4	AY13	
4	IO_L36N_4	AM14	
4	IO_L36P_4/VREF_4	AL14	
4	IO_L76N_4	AR15	
4	IO_L76P_4	AT14	
4	IO_L77N_4	AV14	
4	IO_L77P_4	AU14	
4	IO_L78N_4	AP14	
4	IO_L78P_4	AN14	
4	IO_L79N_4	AW15	
4	IO_L79P_4	AY14	
4	IO_L80_4/No_Pair	BB14	
4	IO_L83_4/No_Pair	BA14	
4	IO_L84N_4	AM15	
4	IO_L84P_4	AL15	
4	IO_L85N_4	AT16	
4	IO_L85P_4	AT15	
4	IO_L86N_4	AV15	
4	IO_L86P_4	AU15	
4	IO_L87N_4	AP15	
4	IO_L87P_4/VREF_4	AN15	
4	IO_L37N_4	AY16	
4	IO_L37P_4	AY15	
4	IO_L38N_4	BB15	
4	IO_L38P_4	BA15	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
6	IO_L02P_6	BA34	
6	IO_L02N_6	AY34	
6	IO_L03P_6	BB37	
6	IO_L03N_6/VREF_6	BA37	
6	IO_L04P_6	BB36	
6	IO_L04N_6	BA36	
6	IO_L05P_6	AW34	
6	IO_L05N_6	AW35	
6	IO_L06P_6	BB35	
6	IO_L06N_6	BA35	
6	IO_L73P_6	BA38	
6	IO_L73N_6	AY38	
6	IO_L74P_6	AU34	
6	IO_L74N_6	AT34	
6	IO_L75P_6	AY39	
6	IO_L75N_6/VREF_6	AY40	
6	IO_L76P_6	AY37	
6	IO_L76N_6	AW36	
6	IO_L77P_6	AR34	
6	IO_L77N_6	AR35	
6	IO_L78P_6	AY35	
6	IO_L78N_6	AY36	
6	IO_L79P_6	AW41	
6	IO_L79N_6	AW42	
6	IO_L80P_6	AP35	
6	IO_L80N_6	AN34	
6	IO_L81P_6	AW40	
6	IO_L81N_6/VREF_6	AV40	
6	IO_L82P_6	AW39	
6	IO_L82N_6	AV39	
6	IO_L83P_6	AM34	
6	IO_L83N_6	AM35	
6	IO_L84P_6	AW38	
6	IO_L84N_6	AV37	
6	IO_L61P_6	AV41	
6	IO_L61N_6	AU40	
6	IO_L62P_6	AL34	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
N/A	GND	AC25	
N/A	GND	AB25	
N/A	GND	AA25	
N/A	GND	Y25	
N/A	GND	W25	
N/A	GND	V25	
N/A	GND	U25	
N/A	GND	AL24	
N/A	GND	AF24	
N/A	GND	AE24	
N/A	GND	AD24	
N/A	GND	AC24	
N/A	GND	AB24	
N/A	GND	AA24	
N/A	GND	Y24	
N/A	GND	W24	
N/A	GND	V24	
N/A	GND	U24	
N/A	GND	M24	
N/A	GND	BB23	
N/A	GND	AV23	
N/A	GND	AP23	
N/A	GND	AF23	
N/A	GND	AE23	
N/A	GND	AD23	
N/A	GND	AC23	
N/A	GND	AB23	
N/A	GND	AA23	
N/A	GND	Y23	
N/A	GND	W23	
N/A	GND	V23	
N/A	GND	U23	
N/A	GND	J23	
N/A	GND	E23	
N/A	GND	A23	
N/A	GND	AF22	
N/A	GND	AE22	